

# AO8403

# P-Channel Enhancement Mode Field Effect Transistor

## **General Description**

The AO8403 uses advanced trench technology to provide excellent  $R_{\text{DS(ON)}}$ , low gate charge and operation with gate voltages as low as 1.8V. This device is suitable for use as a load switch or in PWM applications. It is ESD protected.

#### **Features**

 $V_{DS}(V) = -20V$ 

 $I_D = -4 A$ 

 $R_{DS(ON)}$  < 42m $\Omega$  (V<sub>GS</sub> = -4.5V)

 $R_{DS(ON)}$  < 52m $\Omega$  (V<sub>GS</sub> = -2.5V)

 $R_{DS(ON)}$  < 70m $\Omega$  ( $V_{GS}$  = -1.8V)

ESD Rating: 3000V HBM



Absolute Maximum Ratings T <sub>A</sub> =25°C unless otherwise noted									
Parameter		Symbol	Maximum	Units					
Drain-Source Voltage		$V_{DS}$	-20	V					
Gate-Source Voltage		$V_{GS}$	±8	V					
Continuous Drain	T <sub>A</sub> =25°C		-4						
Current <sup>A</sup>	T <sub>A</sub> =70°C	$I_D$	-3.5	А					
Pulsed Drain Current <sup>B</sup>		I <sub>DM</sub>	-30						
	T <sub>A</sub> =25°C	D	1.5	W					
Power Dissipation A	T <sub>A</sub> =70°C	$-P_D$	1	VV					
Junction and Storage Temperature Range		$T_J$ , $T_{STG}$	-55 to 150	°C					

Thermal Characteristics								
Parameter		Symbol	Тур	Тур Мах				
Maximum Junction-to-Ambient A	t ≤ 10s	≤ 10s		83	°C/W			
Maximum Junction-to-Ambient <sup>A</sup>	Steady-State R <sub>0JA</sub>		89	120	°C/W			
Maximum Junction-to-Lead <sup>C</sup>	Steady-State	$R_{\theta JL}$	53	70	°C/W			

### Electrical Characteristics (T<sub>J</sub>=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Max	Units
STATIC I	PARAMETERS					
$BV_{DSS}$	Drain-Source Breakdown Voltage	$I_D = -250 \mu A, V_{GS} = 0 V$	-20			V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> =-16V, V <sub>GS</sub> =0V			-1	μА
	Zero Gate voltage Drain Current	T <sub>J</sub> =55°	С		-5	μΑ
$I_{GSS}$	Gate-Body leakage current	$V_{DS}$ =0V, $V_{GS}$ =±4.5V			±1	μΑ
		$V_{DS}$ =0V, $V_{GS}$ =±8V			±10	μΑ
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS} I_{D}=-250\mu A$	-0.3	-0.55	-1	
$I_{D(ON)}$	On state drain current	$V_{GS}$ =-4.5V, $V_{DS}$ =-5V	-25			Α
R <sub>DS(ON)</sub> Stat		V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-4A		35	42	mΩ
	Static Drain-Source On-Resistance	T <sub>J</sub> =125°	С	48	60	
	Static Dialii-Source Off-Nesistance	$V_{GS}$ =-2.5V, $I_D$ =-4A		45	52	mΩ
		$V_{GS}$ =-1.8V, $I_D$ =-3A		56	70	mΩ
<b>g</b> FS	Forward Transconductance	$V_{DS}$ =-5V, $I_D$ =-4A	8	16		S
$V_{SD}$	Diode Forward Voltage	I <sub>S</sub> =-1A,V <sub>GS</sub> =0V		-0.78	-1	V
$I_S$	I <sub>S</sub> Maximum Body-Diode Continuous Current				-2.2	Α
DYNAMI	C PARAMETERS					
$C_{\text{iss}}$	Input Capacitance			1450		pF
Coss	Output Capacitance	$V_{GS}$ =0V, $V_{DS}$ =-10V, f=1MHz		205		pF
C <sub>rss</sub>	Reverse Transfer Capacitance			160		pF
$R_g$	Gate resistance	V <sub>GS</sub> =0V, V <sub>DS</sub> =0V, f=1MHz		6.5		Ω
SWITCH	ING PARAMETERS					
$Q_g$	Total Gate Charge			17.2		nC
$Q_{gs}$	Gate Source Charge	$V_{GS}$ =-4.5V, $V_{DS}$ =-10V, $I_{D}$ =-4A		1.3		nC
$Q_{gd}$	Gate Drain Charge			4.5		nC
t <sub>D(on)</sub>	Turn-On DelayTime			9.5		ns
t <sub>r</sub>	Turn-On Rise Time	$V_{GS}$ =-4.5V, $V_{DS}$ =-10V, $R_L$ =2.5 $\Omega$	2,	17		ns
$t_{D(off)}$	Turn-Off DelayTime	$R_{GEN}$ =3 $\Omega$		94		ns
t <sub>f</sub>	Turn-Off Fall Time			35		ns
t <sub>rr</sub>	Body Diode Reverse Recovery Time	I <sub>F</sub> =-4A, dI/dt=100A/μs		31		ns
Q <sub>rr</sub>	Body Diode Reverse Recovery Charge	I <sub>F</sub> =-4A, dI/dt=100A/μs		13.8		nC

A: The value of  $R_{\theta,JA}$  is measured with the device mounted on  $1\text{in}^2$  FR-4 board with 2oz. Copper, in a still air environment with  $T_A$  =25°C. The value in any a given application depends on the user's specific board design. The current rating is based on the t≤ 10s thermal resistance rating.

B: Repetitive rating, pulse width limited by junction temperature.

C. The R  $_{\theta JA}$  is the sum of the thermal impedence from junction to lead  $R_{\theta JL}$  and lead to ambient.

D. The static characteristics in Figures 1 to 6,12,14 are obtained using 80 µs pulses, duty cycle 0.5% max.

E. These tests are performed with the device mounted on 1 in  $^2$  FR-4 board with 2oz. Copper, in a still air environment with  $T_A$ =25 °C. The SOA curve provides a single pulse rating.